



### **DUAL N-CHANNEL ENHANCEMENT MODE MOSFET**

### **Product Summary**

Device	BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub> T <sub>A</sub> = +25°C
N-Channel	20V	35mΩ @ V <sub>GS</sub> = 4.5V	4.6A
N-Charine	200	43mΩ @ V <sub>GS</sub> = 2.5V	4.2A

### **Description**

This new generation MOSFET is designed to minimize the on-state resistance ( $R_{DS(ON)}$ ) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

### **Applications**

- Backlighting
- DC-DC Converters
- Power Management Functions

### **Features and Benefits**

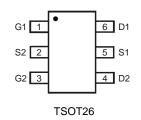
- Low On-Resistance
- Low Input Capacitance
- · Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN2053UVTQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

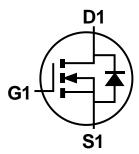
https://www.diodes.com/quality/product-definitions/

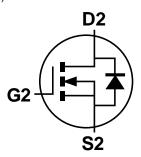
### **Mechanical Data**

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe.
  Solderable per MIL-STD-202, Method 208 (2)
- Weight: 0.013 grams (Approximate)









**Equivalent Circuit** 

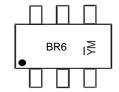
## **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMN2053UVTQ-7	TSOT26	3,000 / Tape & Reel
DMN2053UVTQ-13	TSOT26	10,000 / Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



BR6= Product Type Marking Code  $\underline{YM}$  = Date Code Marking  $\overline{Y}$  = Year (ex: H = 2020) M = Month (ex: 9 = September)

#### Date Code Key

Year	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	G	Н		J	K	L	М	N	0	Р	R	S
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	VDSS	20	V	
Gate-Source Voltage		Vgss	±12	V
Continuous Drain Current (Note 6) V <sub>GS</sub> = 4.5V	ID	4.6 3.7	А	
Maximum Continuous Body Diode Forward Current (Note	Is	1.4	Α	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		IDM	22	A

# **Thermal Characteristics**

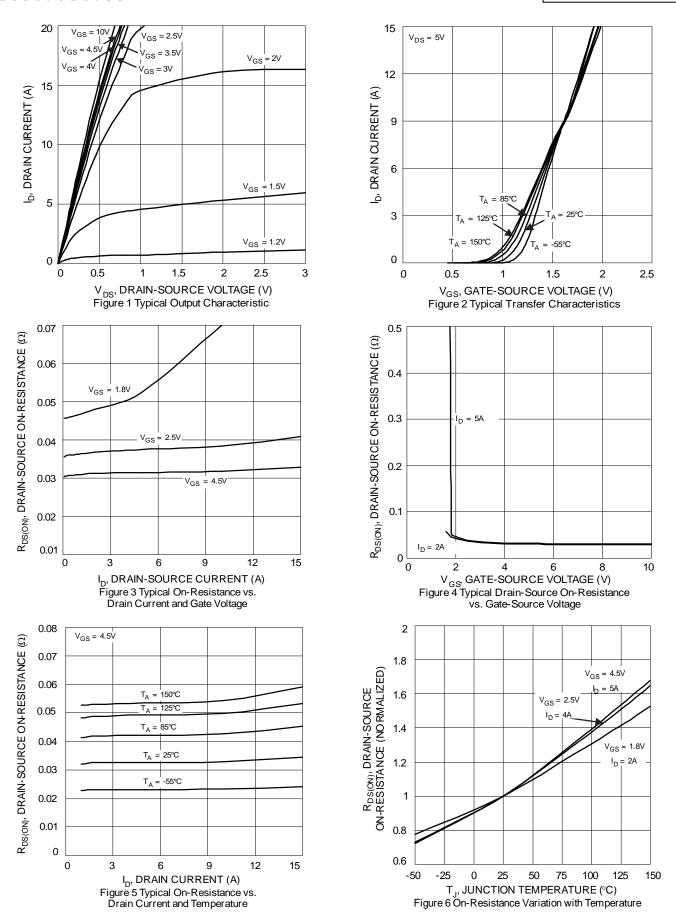
Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	$P_{D}$	0.7	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	173	°C/W
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	PD	1.1	W
Thermal Resistance, Junction to Ambient (Note 6)	RθJA	108	°C/W	
Thermal Resistance, Junction to Case	R <sub>θ</sub> JC	37	C/VV	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

## **Electrical Characteristics** (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	1.0	μA	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 12V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(TH)	0.4	_	1.0	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
			26	35		$V_{GS} = 4.5V, I_{D} = 5.0A$	
Static Drain-Source On-Resistance	RDS(ON)	_	31	43	$m\Omega$	Vgs = 2.5V, ID = 4.0A	
			43	56		VGS = 1.8V, ID = 2.0A	
Diode Forward Voltage	$V_{SD}$	_	0.7	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 1A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	369	_		10111	
Output Capacitance	Coss	_	54	_	pF	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	32	_		I = 1.0WHZ	
Gate Resistance	Rg	_	4.1	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	3.6	_			
Gate-Source Charge	Qgs		0.4	_	nC	$V_{GS} = 4.5V, V_{DS} = 10V, I_D = 6A$	
Gate-Drain Charge	Q <sub>gd</sub>	_	1.0	_			
Turn-On Delay Time	tD(ON)		2.6	_			
Turn-On Rise Time	t <sub>R</sub>		3.0	_		Vps = 10V. Vgs = 5V.	
Turn-Off Delay Time	tD(OFF)	_	12.5	_	ns	$R_G = 6\Omega$ , $I_D = 6A$	
Turn-Off Fall Time	tF	_	3.6	_			
Reverse Recovery Time	trr	_	6.0	_	ns	1. 10. 1/1/2 1000/	
Reverse Recovery Charge	Qrr	_	0.9	_	nC	I <sub>F</sub> = 1A, di/dt = 100A/μs	

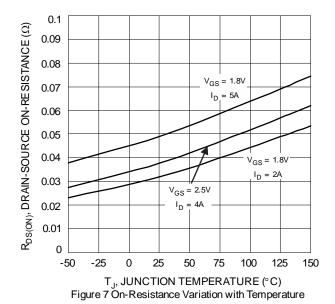
- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- Device mounted on FR-4 substrate PC board, 202 copper, with minimum recommended performance on FR-4 substrate PC board, 202 copper, with 1inch square copper plate.
  Short duration pulse test used to minimize self-heating effect.
  Guaranteed by design. Not subject to production testing.

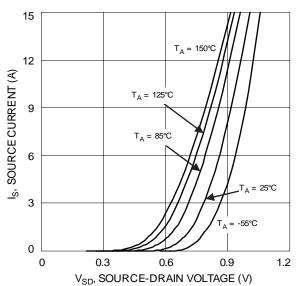


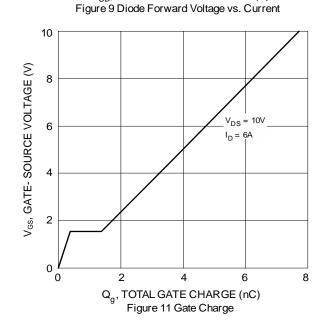












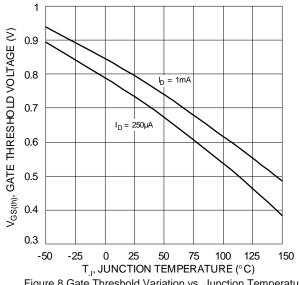
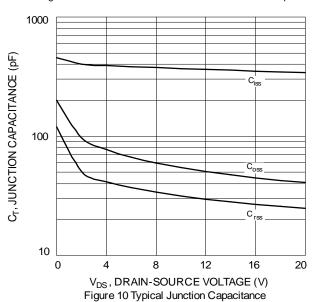


Figure 8 Gate Threshold Variation vs. Junction Temperature

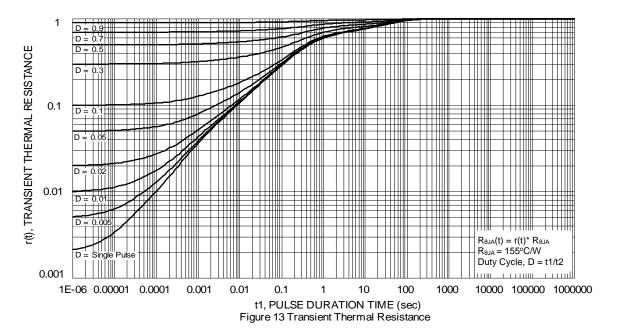


100 R<sub>DS(on)</sub> Limited 10 ID, DRAIN CURRENT (A) 0.1 T<sub>J(max)</sub> = 150°C T<sub>C</sub> = 25°C V<sub>GS</sub> = 4.5V Single Pulse DUT on 1\*MRP Board 0.01 0.1 100 V<sub>DS</sub>, DRAIN-SOURCE VOLTAGE (V)

Figure 12 SOA, Safe Operation Area

DMN2053UVTQ Document number: DS41733 Rev. 2 - 2



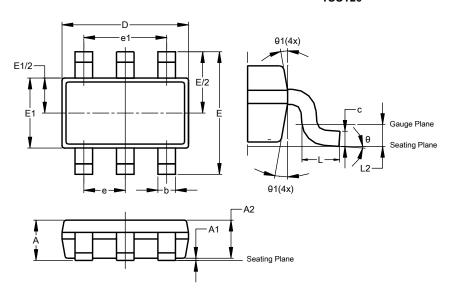




## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### TSOT26

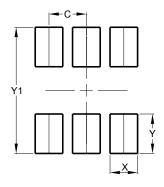


	TSOT26						
Dim	Min	Max	Тур				
Α	_	1.00	_				
A1	0.010	0.100	_				
A2	0.840	0.900	_				
ם	2.800	3.000	2.900				
Е	2	.800 BS	С				
E1	1.500	1.700	1.600				
b	0.300	0.450	_				
С	0.120	0.200	_				
е	0.950 BSC						
e1	1	1.900 BSC					
L	0.30 0.50 —						
L2		.250 BS	С				
θ	0°	8°	4°				
θ1	4°	12°	_				
Δ	All Dimensions in mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### TSOT26



Dimensions	Value (in mm)
C	0.950
Х	0.700
Y	1.000
Y1	3 200



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